

[54] **PRINTED CIRCUIT BOARD COMPONENT MOUNTING MACHINE**

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[73] Assignee: **CAPS Industries**, San Marino, Calif.

[**] Term: **14 Years**

[21] Appl. No.: **450,681**

[22] Filed: **Dec. 17, 1982**

[52] U.S. Cl. **D15/199**

[58] Field of Search D15/122, 199; 29/720, 29/721, 739

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[57]

CLAIM

The ornamental design for a printed circuit board component mounting machine, substantially as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a printed circuit board component mounting machine showing our new design;

FIG. 2 is a front elevational view thereof;

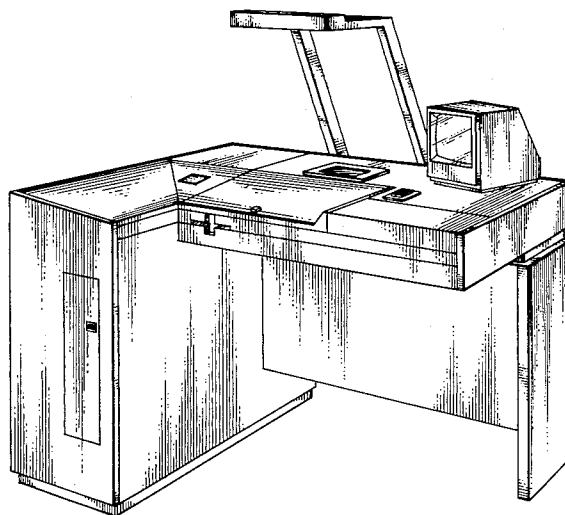
FIG. 3 is a side elevational view taken from the right of FIG. 1;

FIG. 4 is a rear elevational view thereof;

FIG. 5 is a side elevational view taken from the left of FIG. 1;

FIG. 6 is a top plan view thereof;

FIG. 7 is a perspective view of a second embodiment of the design of FIG. 1, the only difference being the omission of the video display element.



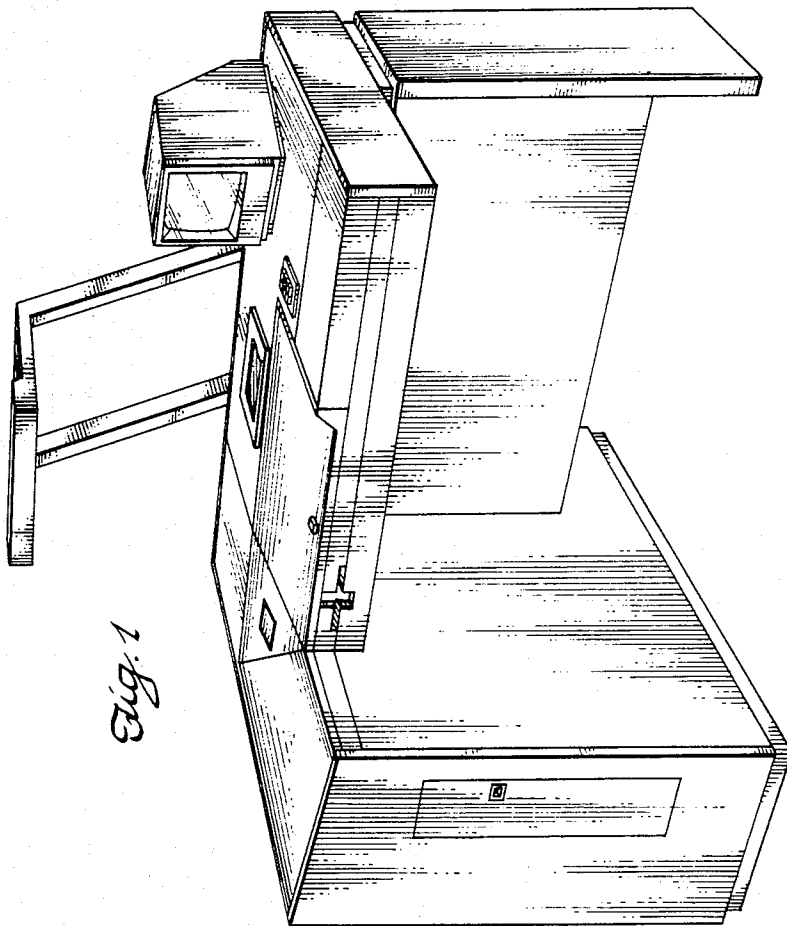


Fig. 1

Fig. 2

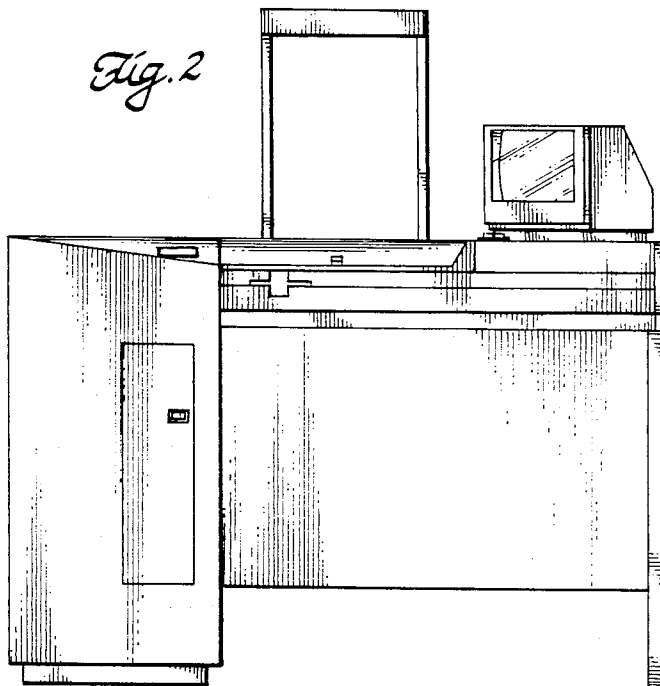


Fig. 3

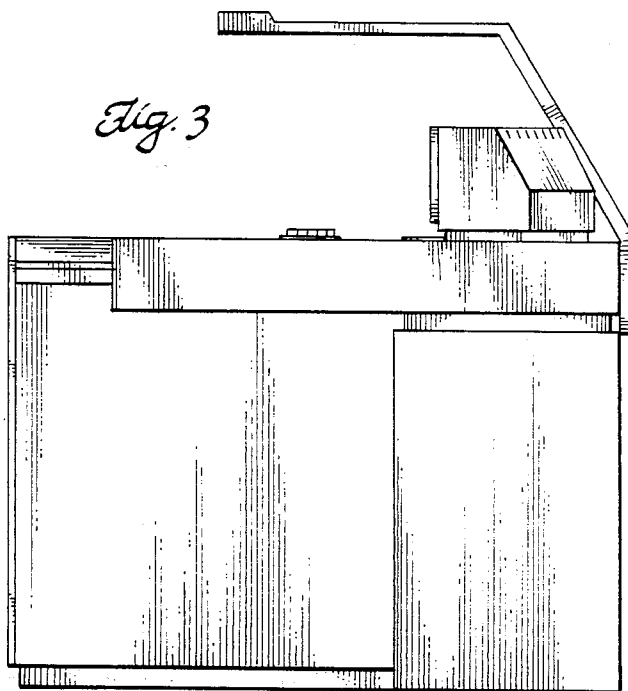


Fig. 4

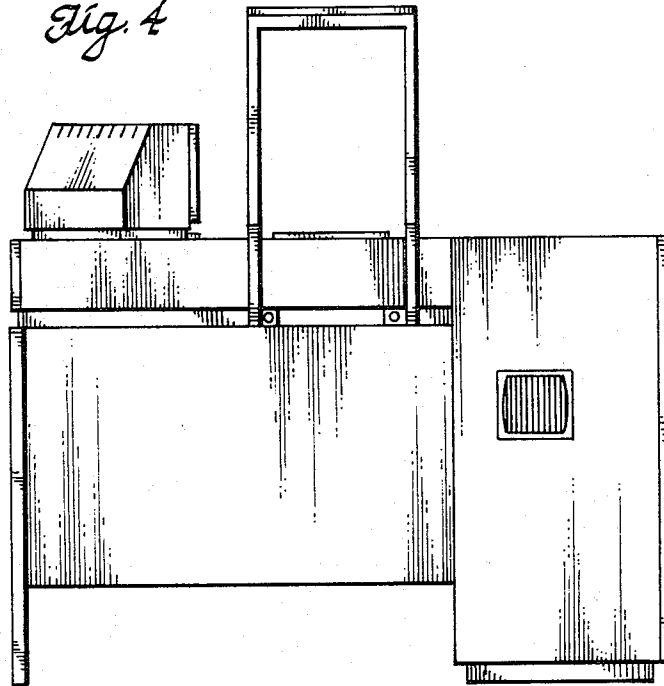


Fig. 5

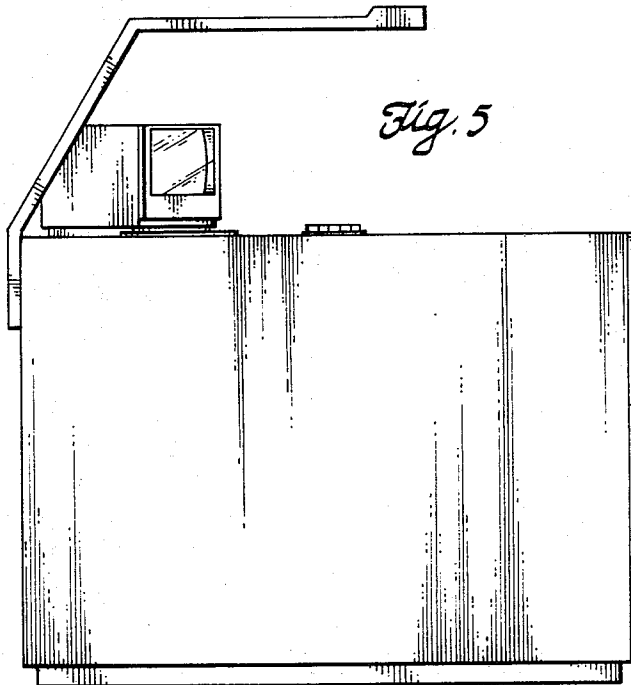


Fig. 6

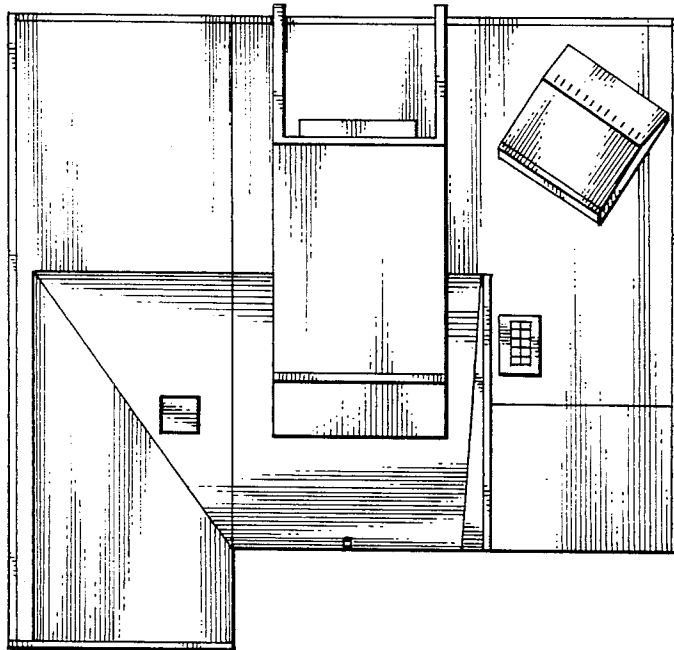


Fig. 7

